Low Output Voltage, Ultra-Fast 1.0 A Low Dropout Linear Regulator with Enable

The NCP5661/NCV5661 is a high performance, low dropout linear regulator designed for high power applications that require up to 1.0 A current. It is offered in both fixed and adjustable output versions. With output voltages as low as 0.9 V and ultra-fast response times for load transients, the NCP5661/NCV5661 also provides additional features such as Enable and Error Flag (for the fixed output version), increasing the utility of these devices. A thermally robust, 5 pin DPAK or DFN 3x3.3 mm, combined with an architecture that offers low ground current (independent of load), provides for a superior high-current LDO solution.

Features

- Ultra-Fast Transient Response (Settling Time: 1–3 μs)
- Low Noise Without Bypass Capacitor (26 μV_{rms)}
- Low Ground Current Independent of Load (3.0 mA Maximum)
- Fixed/Adjustable Output Voltage Versions
- Enable Function
- Error Flag (Fixed Output Version)
- Current Limit Protection
- Thermal Protection
- 0.9 V Reference Voltage for Ultra-Low Output Operation
- Power Supply Rejection Ratio > 65 dB
- NCV Prefix for Automotive and Other Applications Requiring AECQ-100 Qualified Site and Change Controls
- These are Pb-Free Devices

Applications

- Servers
- ASIC Power Supplies
- Post Regulation for Power Supplies
- Constant Current Source
- Networking Equipment
- Gaming and STB Modules



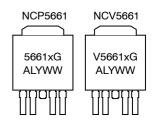
ON Semiconductor®

http://onsemi.com

MARKING DIAGRAMS



DPAK-5 CENTER LEAD CROP CASE 175AA









x = A for Adjustable Version

B for Fixed 1.2 V

C for Fixed 3.3 V

D for Fixed 1.5 V E for Fixed 1.8 V

F for Fixed 2.5 V

G for Fixed 2.8 V

H for Fixed 3.0 V

zzz = 12 for Fixed 1.2 V

15 for Fixed 1.5 V

18 for Fixed 1.8 V

25 for Fixed 2.5 V

28 for Fixed 2.8 V

30 for Fixed 3.0 V

30 for Fixed 3.0 V

33 for Fixed 3.3 V ADJ for Adjustable Version

A = Assembly Location

L = Wafer Lot

Y = Year

WW = Work Week

G = Pb-Free

■ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

PIN FUNCTION DESCRIPTION

| Pin Adj/Fixed DFN6 | Pin Adj/Fixed DPAK-5 | Pin Name | Description |
|--------------------------|----------------------------|-------------------------------|---|
| D1 110 | DI AIL 0 | i ili italile | Description |
| 1 | 1 | Enable | This pin allows for on/off control of the regulator. To disable the device, connect to Ground. If this function is not in use, connect to $V_{\rm in}$. |
| 2,3 | 2 | V _{in} | Positive Power Supply Input Voltage |
| 4, EPAD | 3, TAB | Ground | Power Supply Ground |
| 5 | 4 | V _{out} | Regulated Output Voltage |
| 6 | 5 | Adj (Adjustable Version) | This pin is connected to the resistor divider network and programs the output voltage. |
| 6 | 5 | Error Flag (Fixed Version) | An Error Flag is triggered when the output voltage is out of regulation excluding transient signals that may occur. Requires a pullup resistor \approx 100 k Ω . |

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|---------------------------------------|------------------|------|
| Input Voltage | V _{in} | 18 | V |
| Output Pin Voltage | V _{out} | -0.3 to Vin +0.3 | V |
| Adjust Pin Voltage | V_{adj} | -0.3 to Vin +0.3 | V |
| Enable Pin Voltage | V _{en} | -0.3 to Vin +0.3 | V |
| Error Flag Voltage | V _{ef} | -0.3 to Vin +0.3 | V |
| Error Flag Current | l _{ef} | 3.0 | mA |
| Thermal Characteristics, DPAK-5 (Note 1) Thermal Resistance, Junction-to-Air Thermal Resistance, Junction-to-Case | R _{θJA} R _θ JC | 100 8.0 | °C/W |
| Thermal Characteristics, DFN6 (Note 2) Thermal Resistance, Junction-to-Air Thermal Resistance, Junction-to-Lead (Note 3) | R _{eJA} R _{eJL} | 82 18 | °C/W |
| Operating Junction Temperature Range | TJ | -40 to +150 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect

NOTE: This device series contains ESD protection and exceeds the following tests:

Human Body Model (HBM) JESD 22-A114-B

Machine Model (MM) JESD 22-A115-A.

The maximum package power dissipation is:

$$P_D = \frac{T_{J(max)} - T_{A}}{R_{\theta JA}}$$

The bipolar process employed for this IC is fully characterized and rated for reliable 18 V V_{CCmax} operation. To avoid damaging the part or degrading it's reliability, power dissipation transients should be limited to under 20 W for DPAK.

For open-circuit to short-circuit transient,

- P_{DTransient} = V_{CCmax} * I_{SC}.

 1. 1 oz copper, 0.26 in² copper area (minimum pad)
- 2. 1 oz copper, 1 in² copper area
- 3. Lead 2

ELECTRICAL CHARACTERISTICS

 $(V_{in}-V_{out}=1.5~V,~for~typical~values~T_{J}=25^{\circ}C,~for~min/max~values~T_{J}=-40^{\circ}C~to~125^{\circ}C,~C_{in}=C_{out}=150~\mu F~unless~otherwise~noted.)$

| 5 | | · III Out 1 | | | , |
|--|------------------------------------|---------------------|---------------|---------------------|---------------|
| Characteristic | Symbol | Min | Тур | Max | Unit |
| ADJUSTABLE OUTPUT VERSION | | | | | |
| Input Voltage | V _{in} | 2.0 | _ | 9.0 | V |
| Output Noise Voltage (f = 10 Hz to 100 kHz) | V _n | - | 26 | - | μV_{rms} |
| Output Voltage Accuracy $T_J = 25^{\circ}\text{C (I}_{out} = 10 \text{ mA to } 1.0 \text{ A})$ $T_J = -20 \text{ to } +125^{\circ}\text{C (I}_{out} = 10 \text{ mA to } 1.0 \text{ A})$ $T_J = -40 \text{ to } +150^{\circ}\text{C (I}_{out} = 10 \text{ mA to } 1.0 \text{ A})$ | | -1% -1.5% -2% | - 0.9 - | +1% +1.5% +2% | V |
| Adjustable Pin Input Current | I _{adj} | - | 40 | - | nA |
| Line Regulation (I_{out} = 10 mA, V_{out} +1.5 V < V_{in} < 7.0 V) | REG _{line} | - | 0.03 | - | % |
| Load Regulation (10 mA < I _{out} < 1.0 A) | REG _{load} | - | 0.03 | - | % |
| Dropout Voltage (I _{out} = 1.0 A) | V_{DO} | - | 1.0 | 1.3 | V |
| Peak Output Current Limit | l _{out} | 1.0 | - | - | Α |
| Internal Current Limitation | I _{lim} | - | 1.5 | - | Α |
| Ripple Rejection (120 Hz) Ripple Rejection (1.0 kHz) | RR | - - | 70 65 | - - | dB |
| Thermal Shutdown (Guaranteed by Design) | | - | 160 | - | °C |
| Ground Current I _{out} = 1.0 A Disabled State | I _q I _{qds} | - - | 1.3 10 | 3.0 300 | mA μA |
| Enable Input Threshold Voltage Voltage Increasing, On State, Logic High Voltage Decreasing, Off State, Logic Low | V _{en} | 1.3 - | - - | - 0.3 | V |
| Enable Input Current $ {\rm Enable\ Pin\ Voltage = 0.3\ V_{max} } $ $ {\rm Enable\ Pin\ Voltage = 1.3\ V_{min} } $ | I _{en} | - - | 0.5 0.5 | - - | μΑ |

ELECTRICAL CHARACTERISTICS

 $(V_{in}-V_{out}=1.5~V,~for~typical~values~T_{J}=25^{\circ}C,~for~min/max~values~T_{J}=-40^{\circ}C~to~125^{\circ}C,~C_{in}=C_{out}=150~\mu F~unless~otherwise~noted.)$

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------------------------|--|--|--|-----------------------|
| FIXED OUTPUT VOLTAGE | | | | | |
| Input Voltage | V _{in} | 2.0 | - | 9.0 | V |
| Output Noise Voltage (V _{out} = 0.9 V) | V _n | - | 26 | - | μV_{rms} |
| Output Voltage Accuracy $T_J = 25^{\circ}\text{C (I}_{out} = 10 \text{ mA to } 1.0 \text{ A})$ $T_J = -20 \text{ to } +125^{\circ}\text{C (I}_{out} = 10 \text{ mA to } 1.0 \text{ A})$ $T_J = -40 \text{ to } +150^{\circ}\text{C (I}_{out} = 10 \text{ mA to } 1.0 \text{ A})$ | V _{out} | -1% -1.5% -2% | - V _{out} - | +1% +1.5% +2% | V |
| Line Regulation (I_{out} = 10 mA, V_{out} +1.5 V < V_{in} < 7.0 V) | REG _{line} | _ | 0.03 | - | % |
| Load Regulation (10 mA < I _{out} < 1.0 A) | REG _{load} | - | 0.2 | - | % |
| Dropout Voltage (I _{out} = 1.0 A) | V_{DO} | - | 1.0 | 1.3 | V |
| Peak Output Current Limit | I _{out} | 1.0 | - | - | Α |
| Internal Current Limitation | I _{lim} | - | 1.5 | - | Α |
| Ripple Rejection (120 Hz) Ripple Rejection (1.0 kHz) | RR | - - | 70 65 | - - | dB |
| Thermal Shutdown (Guaranteed by Design) | T _{SHD} | - | 160 | - | °C |
| Ground Current I _{out} = 1.0 A Disabled State | I _q I _{qds} | - - | 1.3 30 | 3.0 300 | mA μA |
| Enable Input Threshold Voltage Voltage Increasing, On State, Logic High Voltage Decreasing, Off State, Logic Low | V _{en} | 1.3 - | - - | - 0.3 | V |
| Enable Input Current | l _{en} | - - | 0.5 0.5 | - - | μΑ |
| Error Flag (Fixed Output) 1.2 V Output 1.5 V Output 1.8 V Output 2.5 V Output 2.8 V Output 3.0 V Output 3.3 V Output | V _{eflt} | 88 88 88 88 88 88 90 | 92 92 92 92 92 92 92 94 | 97 97 97 97 97 97 97 | % of V _{out} |
| Error Flag Output Low Voltage Saturation (I _{ef} = 1.0 mA) | V _{efdo} | - | 200 | - | mV |
| Error Flag Leakage | l _{efleak} | - | 1.0 | - | μΑ |
| Error Flag Blanking Time (Note 4) | T _{ef} | _ | 50 | - | μs |

^{4.} Error Flag Blanking Time

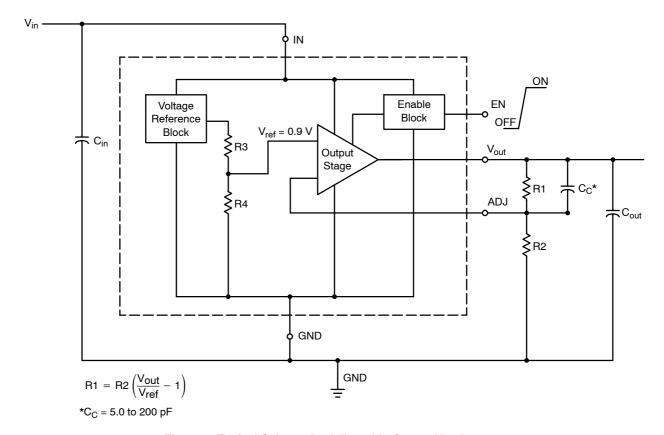


Figure 1. Typical Schematic, Adjustable Output Version

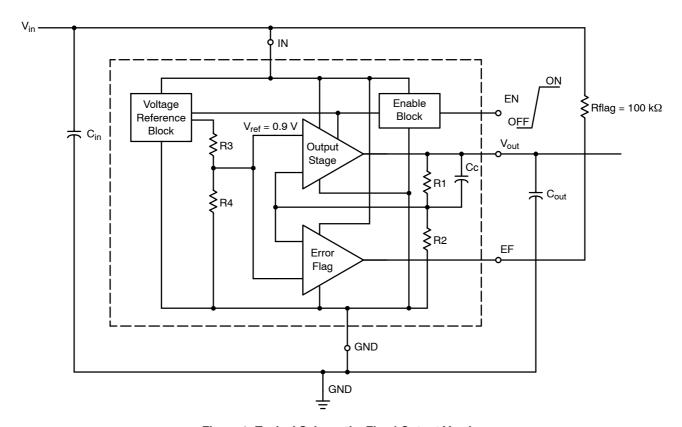
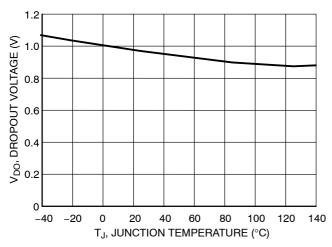


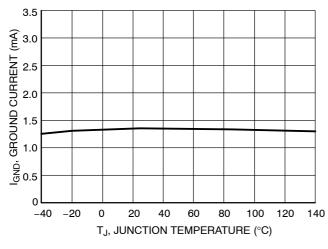
Figure 2. Typical Schematic, Fixed Output Version



1.00 V_{DO}, DROPOUT VOLTAGE (V) 0.95 0.90 0.85 0.80 V_{out} = 2.5 V Adjustable C_{in} = 150 μ F C_{out} = 10 to 150 μ F 0.75 T_J = 25°C 0.70 0.0 0.1 0.2 0.3 0.4 0.5 0.6 0.7 8.0 0.9 I_{out}, OUTPUT CURRENT (A)

Figure 3. Dropout Voltage vs. Temperature

Figure 4. Dropout Voltage vs. Output Current



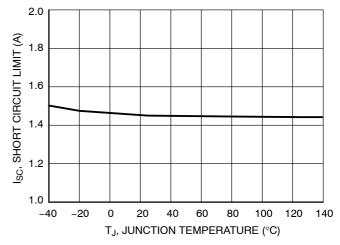
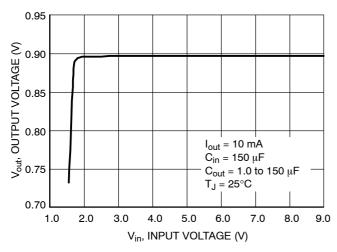


Figure 5. Ground Current vs. Temperature

Figure 6. Short Circuit Current Limit vs. Temperature



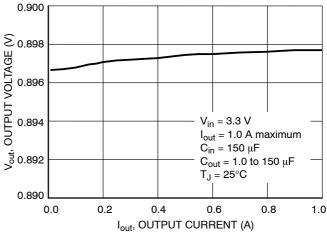


Figure 7. Output Voltage vs. Input Voltage

Figure 8. Output Voltage vs. Output Load Current

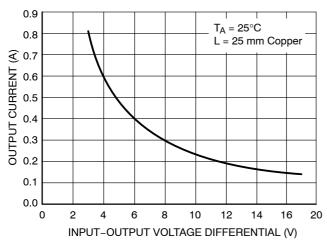


Figure 9. Output Current vs. Input-Output Voltage Differential

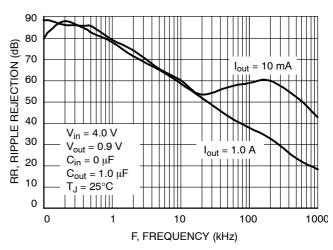


Figure 10. Ripple Rejection vs. Frequency

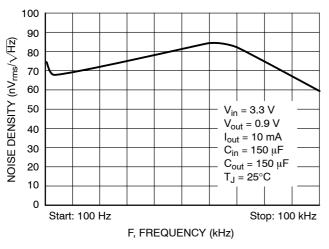


Figure 11. Noise Density vs. Frequency

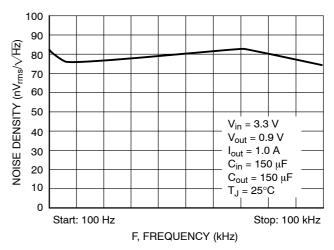


Figure 12. Noise Density vs. Frequency

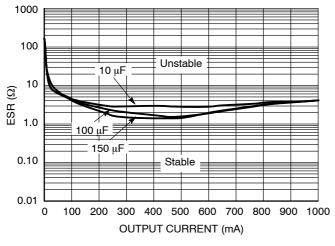


Figure 13. 1.2 Volt Output Stability with Output Capacitor ESR

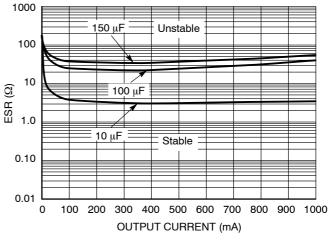


Figure 14. 3.3 Volt Output Stability with Output Capacitor ESR

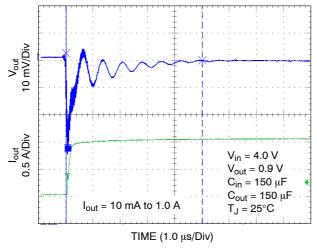


Figure 15. Load Transient Response

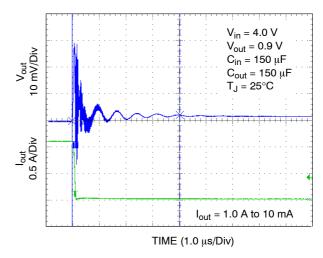


Figure 16. Load Transient Response

APPLICATION INFORMATION

The NCP5661 is a high performance low dropout 1.0 A linear regulator suitable for high power applications, featuring an ultra–fast response time and low noise without a bypass capacitor. It is offered in both fixed and adjustable output versions with voltages as low as 0.9 V. Additional features, such as Enable and Error Flag (fixed output version) increase the utility of the NCP5661. It is thermally robust and includes the safety features necessary during a fault condition, which provide for an attractive high current LDO solution for server, ASIC power supplies, networking equipment applications, and many others.

Input Capacitor

The recommended input capacitor value is a 150 μF OSCON with an Equivalent Series Resistance (ESR) of 50 m Ω . It is especially required if the power source is located more than a few inches from the NCP5661. This capacitor will reduce device sensitivity and enhance the output transient response time. The PCB layout is very important and in order to obtain the optimal solution, the Vin and GND traces should be sufficiently wide to minimize noise and unstable operation.

Output Capacitor

Proper output capacitor selection is required to maintain stability. The NCP5661 is guaranteed to be stable at an output capacitance of, $C_{out} > 10~\mu F$ with an ESR < 300 m Ω over the output current range of 10 mA to 1.0 A. For PCB layout considerations, place the recommended ceramic capacitor close to the output pin and keep the leads short. This should help ensure ultra–fast transient response times.

Adjustable Output Operation

The application circuit for the adjustable output version is shown in Figure 1. The reference voltage is 0.9 V and the adjustable pin current is typically 40 nA. A resistor divider

network, R1 and R2, is calculated using the following formula:

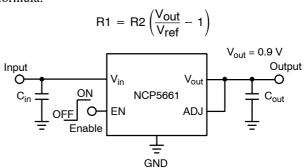


Figure 17. To achieve the minimum output voltage, ADJ to V_{out} has to be connected together

Current Limit Operation

As the peak output current increases beyond its limitation, the device is internally clampled to 1.5 A, thus causing the output voltage to decrease and go out of regulation. This allows the device never to exceed the maximum power dissipation.

Error Flag Operation

The Error Flag pin on the NCP5661 will produce a logic Low when it drops below the nominal output voltage. Refer to the electrical characteristics for the threshold values at which point the Error Flag goes Low. When the NCP5661 is above the nominal output voltage, the Error Flag will remain at logic High.

The external pullup resistor needs to be connected between V_{in} (Pin 1) and the Error Flag pin (Pin 5). A resistor of approximately $100~k\Omega$ is recommended to minimize the current consumption. No pullup resistor is required if the Error Flag output is not being used.

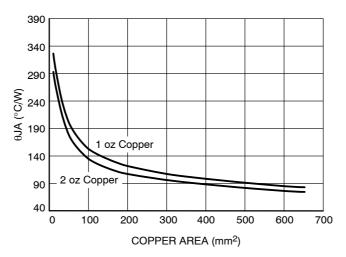


Figure 18. DFN6 Thermal Resistance vs. Copper Area

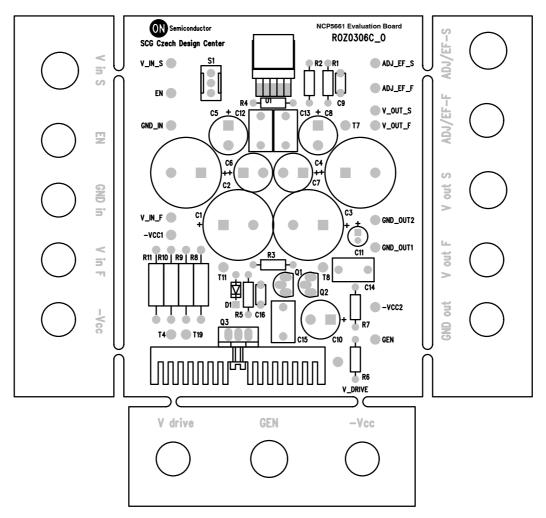


Figure 19. Test Board used for Evaluation

ORDERING INFORMATION

| Device | Nominal Output Voltage | Package | Shipping† | | |
|------------------|---------------------------|----------|------------------|--|--|
| NCP5661DTADJRKG | Adj (Pb-Free) | | | | |
| NCP5661DT12RKG | Fixed, 1.2 V (Pb-Free) | | 2500/Tape & Reel | | |
| NCP5661DT18RKG | Fixed, 1.8 V (Pb-Free) | | | | |
| NCP5661DT33RKG | Fixed, 3.3 V (Pb-Free) | DPAK | | | |
| NCV5661DTADJRKG* | Adj (Pb-Free) | DFAR | | | |
| NCV5661DT12RKG* | Fixed, 1.2 V (Pb-Free) | | | | |
| NCV5661DT18RKG* | Fixed, 1.8 V (Pb-Free) | | | | |
| NCV5661DT33RKG* | Fixed, 3.3 V (Pb-Free) | | | | |
| NCP5661MNADJT2G | Adj (Pb-Free) | | | | |
| NCP5661MN12T2G | Fixed, 1.2 V (Pb-Free) | | | | |
| NCP5661MN15T2G | Fixed, 1.5 V (Pb-Free) | | | | |
| NCP5661MN18T2G | Fixed, 1.8 V (Pb-Free) | | | | |
| NCP5661MN25T2G | Fixed, 2.5 V (Pb-Free) | | | | |
| NCP5661MN28T2G | Fixed, 2.8 V (Pb-Free) | | | | |
| NCP5661MN30T2G | Fixed, 3.0 V (Pb-Free) | | | | |
| NCP5661MN33T2G | Fixed, 3.3 V (Pb-Free) | DFN6 | 0000T A.B. I | | |
| NCV5661MNADJT2G* | Adj (Pb-Free) | 3x3.3 mm | 3000/Tape & Reel | | |
| NCV5661MN12T2G* | Fixed, 1.2 V (Pb-Free) | | | | |
| NCV5661MN15T2G* | Fixed, 1.5 V (Pb-Free) | | | | |
| NCV5661MN18T2G* | Fixed, 1.8 V (Pb-Free) | | | | |
| NCV5661MN25T2G* | Fixed, 2.5 V (Pb-Free) | | | | |
| NCV5661MN28T2G* | Fixed, 2.8 V (Pb-Free) | | | | |
| NCV5661MN30T2G* | Fixed, 3.0 V (Pb-Free) | | | | |
| NCV5661MN33T2G* | Fixed, 3.3 V (Pb-Free) | 1 | | | |
| | | 1 | | | |

NOTE: Additional Fix output voltages are available upon request.

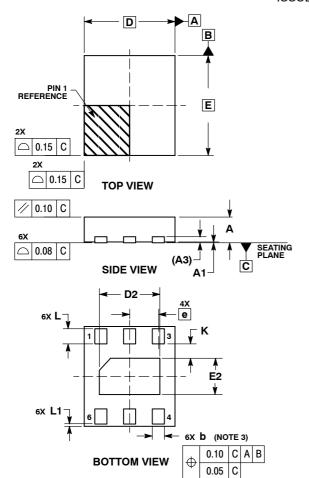
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}NCV rated devices are subjected to and meet the AECQ-100 quality standards.

PACKAGE DIMENSIONS

DFN6 3x3.3 MM, 0.95 PITCH

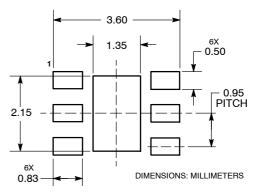
CASE 506AX-01 ISSUE O



- NOTES:
 1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 mm FROM TERMINAL.
 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| | MILLIMETERS | | | |
|-----|-------------|---------|------|--|
| DIM | MIN | MAX | | |
| Α | 0.80 | | 0.90 | |
| A1 | 0.00 | | 0.05 | |
| A3 | 0 | .20 REF | | |
| b | 0.30 | | 0.40 | |
| D | 3.00 BSC | | | |
| D2 | 1.90 | | 2.10 | |
| E | 3.30 BSC | | | |
| E2 | 1.10 | | 1.30 | |
| е | 0.95 BSC | | | |
| K | 0.20 | | | |
| L | 0.40 | | 0.60 | |
| L1 | 0.00 | | 0.15 | |

SOLDERING FOOTPRINT*

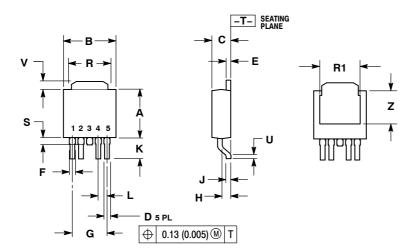


*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

DPAK-5 **CENTER LEAD CROP**

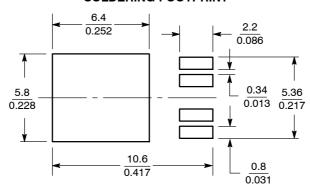
CASE 175AA-01 **ISSUE A**



- NOTES:
 1. DIMENSIONING AND TOLERANCING
- PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

| | INC | HES | MILLIMETERS | | |
|-----|-----------|-------|-------------|------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.235 | 0.245 | 5.97 | 6.22 | |
| В | 0.250 | 0.265 | 6.35 | 6.73 | |
| C | 0.086 | 0.094 | 2.19 | 2.38 | |
| D | 0.020 | 0.028 | 0.51 | 0.71 | |
| Е | 0.018 | 0.023 | 0.46 | 0.58 | |
| F | 0.024 | 0.032 | 0.61 | 0.81 | |
| G | 0.180 | BSC | 4.56 BSC | | |
| Н | 0.034 | 0.040 | 0.87 | 1.01 | |
| J | 0.018 | 0.023 | 0.46 | 0.58 | |
| K | 0.102 | 0.114 | 2.60 | 2.89 | |
| L | 0.045 BSC | | 1.14 BSC | | |
| R | 0.170 | 0.190 | 4.32 | 4.83 | |
| R1 | 0.185 | 0.210 | 4.70 | 5.33 | |
| S | 0.025 | 0.040 | 0.63 | 1.01 | |
| U | 0.020 | | 0.51 | | |
| ٧ | 0.035 | 0.050 | 0.89 | 1.27 | |
| Z | 0.155 | 0.170 | 3.93 | 4.32 | |

SOLDERING FOOTPRINT*



 $\left(\frac{\text{mm}}{\text{inches}}\right)$ SCALE 4:1

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and un are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice on semiconductor and are registered readerlands of semiconductor Components industries, Ite (SCILLC) . Solitude services are inject to make triangles without further holice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada

Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative